**Vishay Siliconix** 

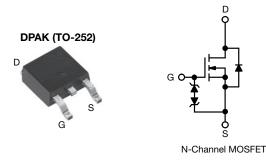
**RoHS** COMPLIANT

HALOGEN

FREE



## **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	2.5			
Q <sub>g</sub> max. (nC)	10.5				
Q <sub>gs</sub> (nC)	3				
Q <sub>gd</sub> (nC)	2				
Configuration	Single				

### FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	DPAK (TO-252)
Lead (Pb)-free and halogen-free	SiHD2N80AE-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	800	v			
Gate-source voltage			V <sub>GS</sub>	± 30	V		
Continuous drain current ( $T_J = 150 \ ^\circ C$ )	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub>	2.9			
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		1.8	А		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	3.6			
Linear derating factor				0.5	W/°C		
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	14.1	mJ		
Maximum power dissipation			PD	62.5	W		
Operating junction and storage temperature ra	ange		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope		T <sub>J</sub> = 125 °C	70		V/ns		
everse diode dv/dt <sup>d</sup>		dv/dt	0.1	V/ns			
Soldering recommendations (peak temperatur	e) c	For 10 s		260	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 1 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25 °C

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THERMAL RESISTANCE RAT	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62			80 AM				
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 2.0				°C/W			
SPECIFICATIONS (T_J = 25 $^\circ C, u$	Inless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μΑ	800	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.8	-	V/°C	
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D = 2$	250 µA	2.0	-	4.0	V	
Gate-source leakage		$V_{GS} = \pm 20 \text{ V}$		-	-	± 10	•		
	I <sub>GSS</sub>	N	$V_{GS} = \pm 30 \text{ V}$			-	± 50	μA	
Zere gete veltege drein ourrent		V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V		-	-	1			
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 640 V	, V <sub>GS</sub> = 0 V	′, T <sub>J</sub> = 125 °C	-	-	10	μA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	ار	<sub>0</sub> = 0.5 A	-	2.5	2.9	Ω	
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub>	= 1 A	-	0.6	-	S	
Dynamic									
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	180	-	-		
Output capacitance	C <sub>oss</sub>			-	10	-			
Reverse transfer capacitance	C <sub>rss</sub>			-	1	-			
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	N 01			-	7	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	42	-			
Total gate charge	Qg				-	7	10.5		
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 1.5 \text{ A}, V_{DS} = 640 \text{ V}$		-	3	-	nC		
Gate-drain charge	Q <sub>gd</sub>				-	2	-		
Turn-on delay time	t <sub>d(on)</sub>				-	13	26	1	
Rise time	t <sub>r</sub>	$V_{DD}$ = 640 V, I_D = 1.5 A, $V_{GS}$ = 10 V, $R_g$ = 4.7 $\Omega$		-	8	16	ns		
Turn-off delay time	t <sub>d(off)</sub>			-	10	20			
Fall time	t <sub>f</sub>			-	23	46			
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		2.0	5.2	10.4	Ω		
Drain-Source Body Diode Characteristi	cs								
Continuous source-drain diode current	١ <sub>S</sub>	showing the	MOSFET symbol showing the		-	-	2.9		
Pulsed diode forward current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	3.6	A		
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V		-	-	1.2	V		
Reverse recovery time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 1 \text{ A},$ di/dt = 100 A/ $\mu$ s, V <sub>R</sub> = 25 V		-	313	626	ns		
Reverse recovery charge	Q <sub>rr</sub>			-	0.7	1.4	μC		
Reverse recovery current	I <sub>RRM</sub>			-	3.8	-	A		

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

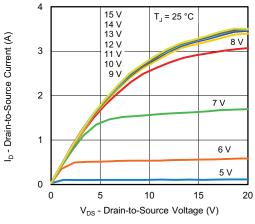


Fig. 1 - Typical Output Characteristics

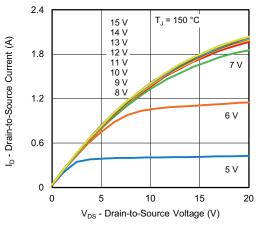


Fig. 2 - Typical Output Characteristics

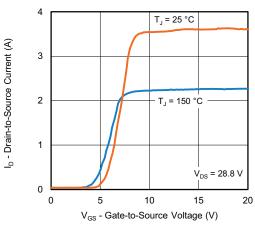


Fig. 3 - Typical Transfer Characteristics

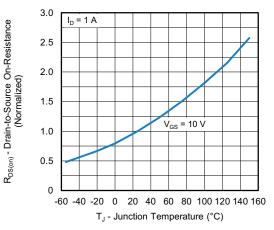


Fig. 4 - Normalized On-Resistance vs. Temperature

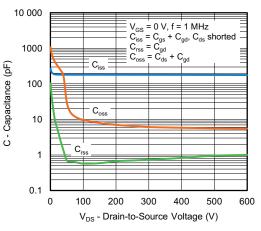
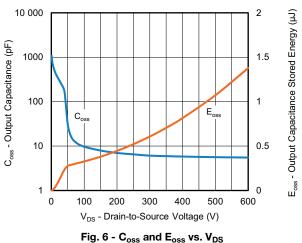


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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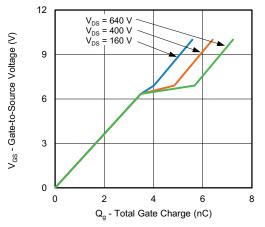


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

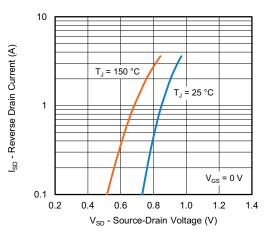


Fig. 8 - Typical Source-Drain Diode Forward Voltage

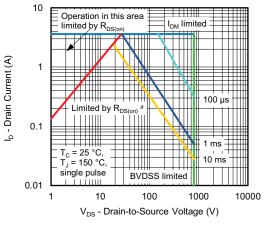


Fig. 9 - Maximum Safe Operating Area

Note

a. V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

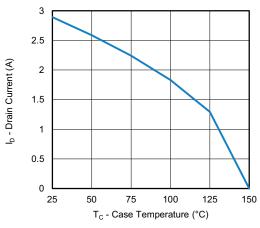


Fig. 10 - Maximum Drain Current vs. Case Temperature

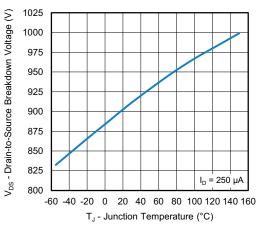


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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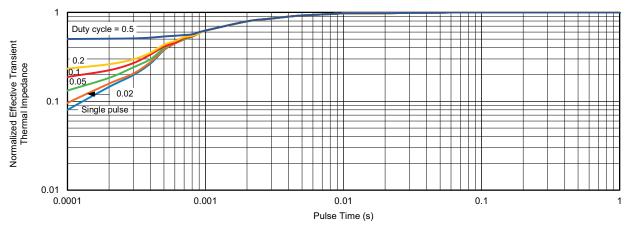


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

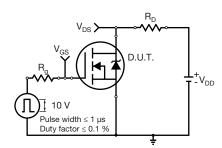


Fig. 13 - Switching Time Test Circuit

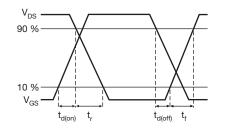


Fig. 14 - Switching Time Waveforms

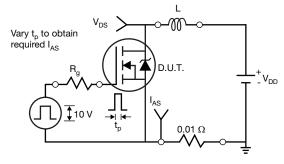


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

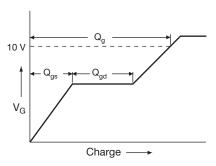
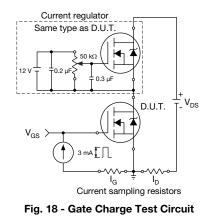


Fig. 17 - Basic Gate Charge Waveform



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#### Peak Diode Recovery dv/dt Test Circuit

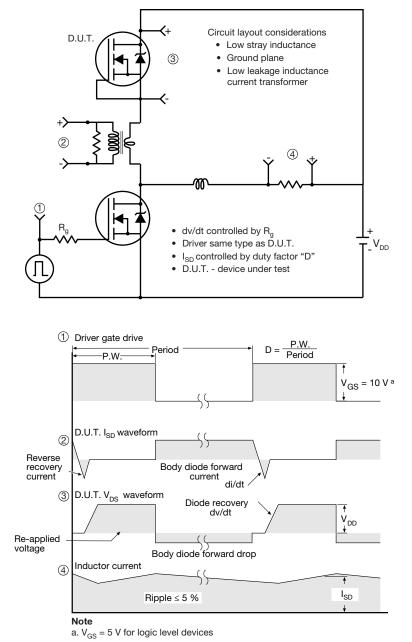


Fig. 19 - For N-Channel

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